

1 Form B Solid State Relay



FEATURES

- Isolation test voltage 3750 V_{RMS}
- Typical R_{ON} 20 Ω
- Load voltage 350 V
- Clean bounce free switching
- Low power consumption
- SMD lead available on tape and reel
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS
COMPLIANT

APPLICATIONS

- General telecom switching
- Security equipment
- Instrumentation
- Industrial controls

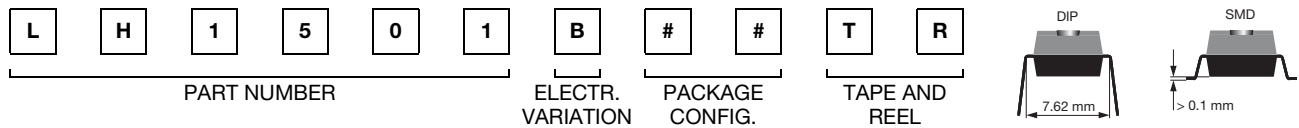
AGENCY APPROVALS

UL1577: file no. E52744
CSA: certification 093751

DESCRIPTION

The LH1501 relays are SPST normally closed switches (1 form B) that can replace electromechanical relays in many applications. The relays are constructed as a multi-chip hybrid device. Actuation control is via an infrared LED. The output switch is a combination of a photodiode array with MOSFET switches and control circuitry. The relays can be configured for AC/DC or DC only operation.

ORDERING INFORMATION



PACKAGE	UL, CSA
SMD-6, tubes	LH1501BAB
SMD-6, tape and reel	LH1501BABTR
DIP-6, tubes	LH1501BT

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
LED continuous forward current		I _F	50	mA
LED reverse voltage	I _R ≤ 10 μA	V _R	5	V
OUTPUT				
DC or peak AC load voltage	I _L ≤ 50 μA	V _L	350	V
Continuous DC load current - bidirectional		I _L	150	mA
Continuous DC load current - unidirectional		I _L	200	mA
Peak load current (single shot)	t = 100 ms	I _P	350	mA
SSR				
Ambient temperature range		T _{amb}	- 40 to + 85	°C
Storage temperature range		T _{stg}	- 40 to + 125	°C
Pin soldering temperature ⁽¹⁾	t = 10 s max.	T _{slid}	260	°C
Input to output isolation voltage	t = 1 s, I _{ISO} = 10 μA max.	V _{ISO}	3750	V _{RMS}
Output power dissipation (continuous)		P _{diss}	550	mW

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- ⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
LED forward current, switch turn-on	$I_L = \pm 150\text{ mA}$, $t = 10\text{ ms}$	I_{Fon}	0.2	0.9		mA
LED forward current, switch turn-off	$V_L = \pm 300\text{ V}$	I_{Foff}		1	2	mA
LED forward voltage	$I_F = 10\text{ mA}$	V_F	1.15	1.26	1.45	V
OUTPUT						
On-resistance, AC/DC: pin 4, 6 (+) to 5 (-)	$I_F = 0\text{ mA}$, $I_L = 50\text{ mA}$	R_{ON}		20	25	Ω
On-resistance, DC: pin 4, 6 (+) to 5 (-)	$I_F = 0\text{ mA}$, $I_L = 100\text{ mA}$	R_{ON}		5	6.25	Ω
Off-resistance	$I_F = 5\text{ mA}$, $V_L = \pm 100\text{ V}$	R_{OFF}	0.1	1.4		G Ω
Off-state leakage current	$I_F = 5\text{ mA}$, $V_L = \pm 350\text{ V}$	I_O		0.08	1	μA
Output capacitance	$I_F = 5\text{ mA}$, $V_L = 50\text{ V}$	C_O		35		pF
TRANSFER						
Capacitance (input to output)	$V_{ISO} = 1\text{ V}$	C_{IO}		3		pF

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

SWITCHING CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{on}		2	3	ms
Turn-off time	$I_F = 5\text{ mA}$, $I_L = 50\text{ mA}$	t_{off}		1	3	ms

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

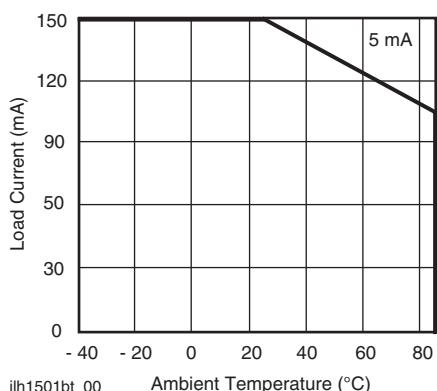


Fig. 1 - Recommended Operating Conditions



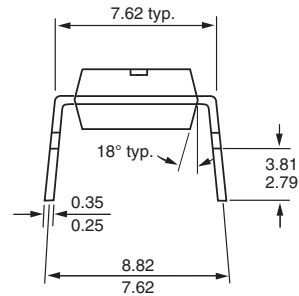
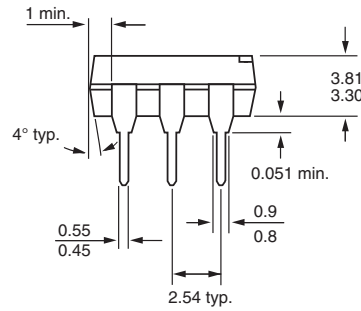
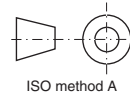
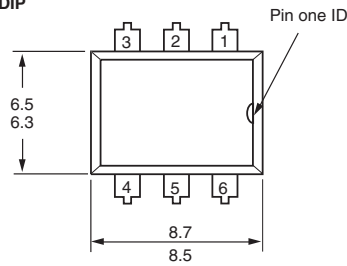
LH1501BAB, LH1501BABTR, LH1501BT

1 Form B Solid State Relay

Vishay Semiconductors

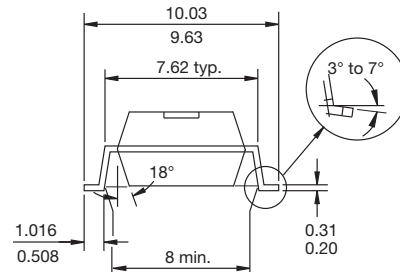
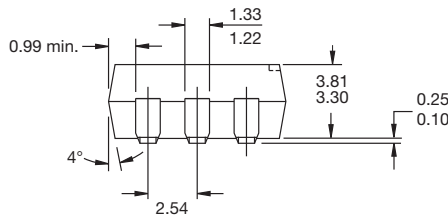
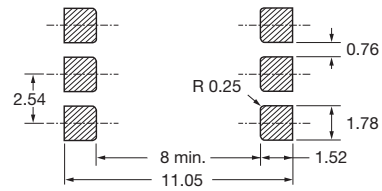
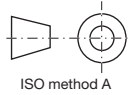
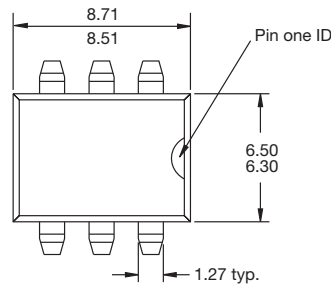
PACKAGE DIMENSIONS in millimeters

DIP



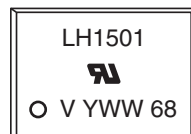
i178001

SMD



i178002

PACKAGE MARKING (example)



Note

- Tape and reel suffix (TR) is not part of the package marking.



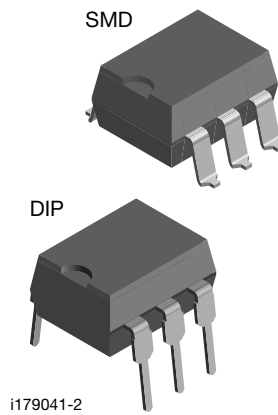
Footprint and Schematic Information for LH1501BAB, LH1501BABTR, LH1501BT

The footprint and schematic symbols for the following parts can be accessed using the associated links. They are available in Eagle, Altium, KiCad, OrCAD / Allegro, Pulsonix, and PADS.

Note that the 3D models for these parts can be found on the Vishay product page.

PART NUMBER	FOOTPRINT / SCHEMATIC
LH1501BAB	www.snapeda.com/parts/LH1501BAB/Vishay/view-part
LH1501BABTR	www.snapeda.com/parts/LH1501BABTR/Vishay/view-part
LH1501BT	www.snapeda.com/parts/LH1501BT/Vishay/view-part

For technical issues and product support, please contact optocoupleranswers@vishay.com.





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